



100V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C				
100V	$52m\Omega$ @ V _{GS} = 10V	5A				
100 V	$75m\Omega$ @ V _{GS} = 4.5V	4.1A				

Description

This new generation MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Features and Benefits

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low On-Resistance
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

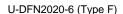
https://www.diodes.com/quality/product-definitions/

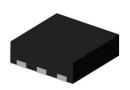
Applications

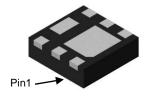
- Power Management Functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

Mechanical Data

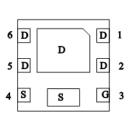
- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.0065 grams (Approximate)



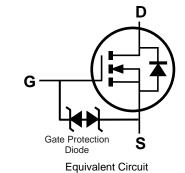




Top View Bottom View







Ordering Information (Note 4)

Part Number	Case	Quantity Per Reel
DMT10H052LFDF-7	U-DFN2020-6 (Type F)	3,000
DMT10H052LFDF-13	U-DFN2020-6 (Type F)	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

U-DFN2020-6 (Type F)



57 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 0 = 2020)

W = Week (ex: a = week 27; z represents week 52 and 53)

X = Internal Code (ex: U = Monday)

Date Code Kev

Date Code Hoy												
Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	9	0	1	2	3	4	5	6	7	8	9	0
Week 1-26			27-52			53						
Code		Α	-Z		a-z			Z				
Internal Code	Sun	1	Mon		Tue	W	ed	Thu		Fri		Sat
Code	Т		U		V	\	٧	Х		Υ		Z

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	VDSS	100	V
Gate-Source Voltage	Vgss	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 6)	lo	5 4	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	IDM	30	Α
Maximum Body Diode Continuous Current	Is	2.3	Α
Pulsed Body Diode Continuous Current (10µs Pulse, Duty C	Ism	30	Α
Avalanche Current, L = 0.1mH (Note 7)	I _{AS}	15.6	Α
Avalanche Energy, L = 0.1mH (Note 7)	Eas	12.2	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Dowar Discination (Note 5)	$T_A = +25^{\circ}C$	D-	0.8	W
Total Power Dissipation (Note 5)	$T_A = +70$ °C	P _D	0.5	VV
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	151	°C/W	
Total Dawer Dissipation (Note 6)	T _A = +25°C	D-	1.9	W
Total Power Dissipation (Note 6)	$T_A = +70$ °C	PD	1.2	VV
Thermal Resistance, Junction to Ambient (Note 6)	R _θ JA	64	°C/W	
Thermal Resistance, Junction to Case (Note 6)	R ₀ JC	11	C/VV	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C	

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.



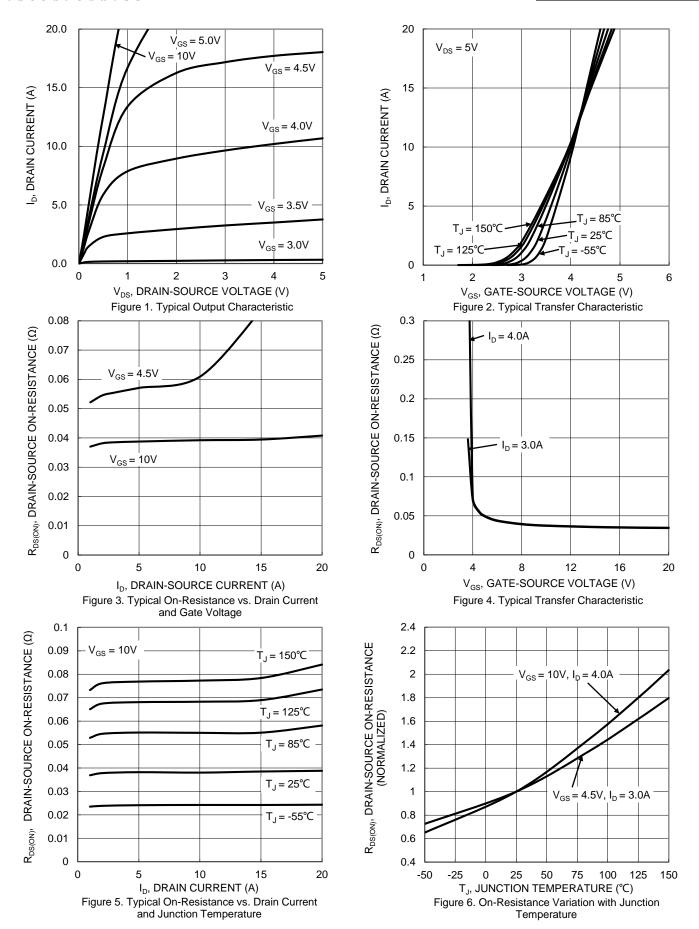
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BVDSS	100	_	_	٧	$V_{GS} = 0V, I_D = 1mA$
Zero Gate Voltage Drain Current	IDSS		_	1	μΑ	V _{DS} = 80V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	1.5	_	3.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	C	_	38	52	mΩ	VGS = 10V, ID = 4A
Static Dialii-Source Off-Resistance	Rds(on)		54	75	mΩ	$V_{GS} = 4.5V, I_{D} = 3A$
Diode Forward Voltage	V _{SD}	_	0.8	1.0	V	$V_{GS} = 0V$, $I_S = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	l	258		рF	\
Output Capacitance	Coss	I	114		рF	V _{DS} = 50V, V _{GS} = 0V, f = 1MHz
Reverse Transfer Capacitance	Crss	-	5.5	_	pF	1 - 1101112
Gate Resistance	Rg	_	6.3	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	2.9	_	nC	
Total Gate Charge (V _{GS} = 10V)	Q_g	_	5.4	_	nC	\/ 50\/ I- 4A
Gate-Source Charge	Q _{gs}	_	0.8	_	nC	$V_{DS} = 50V, I_{D} = 4A$
Gate-Drain Charge	Qgd	_	1.6	_	nC]
Turn-On Delay Time	t _{D(ON)}		3.1	_	ns	
Turn-On Rise Time	t _R		3.8	_	ns	$V_{DS} = 50V$, $R_L = 11\Omega$
Turn-Off Delay Time	tD(OFF)		11.4	_	ns	$V_{GS} = 10V, R_{GEN} = 3\Omega$
Turn-Off Fall Time	tF	_	4.4	_	ns]
Reverse Recovery Time	trr		22.6	_	ns	1 44 41/41 0004/
Reverse Recovery Charge	Q _{RR}	1	43.6	_	nC	I _F = 4A, di/dt = 300A/μs

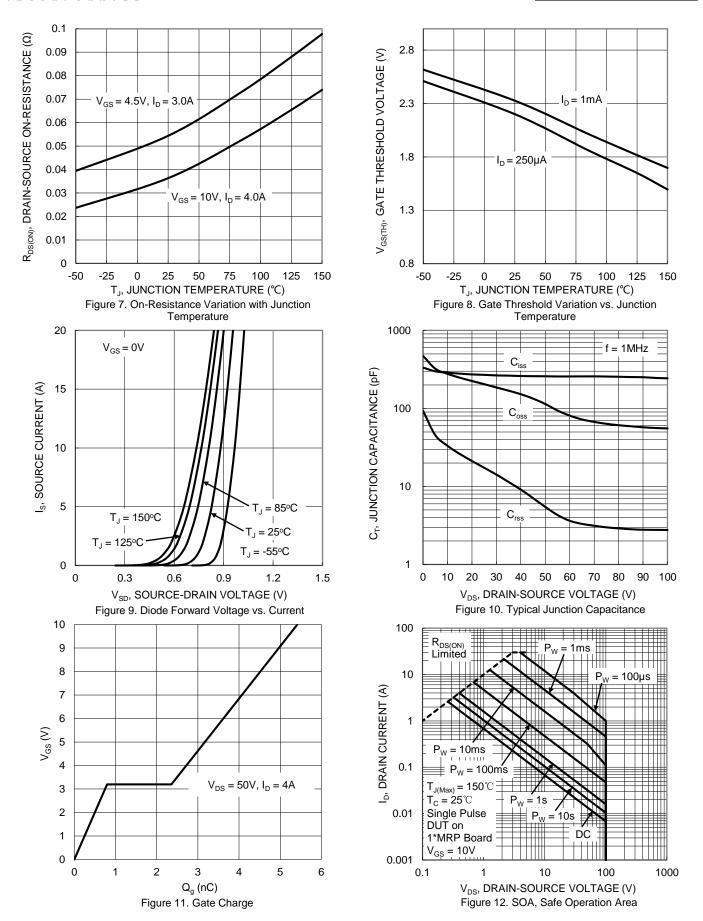
Notes:

^{8.} Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.











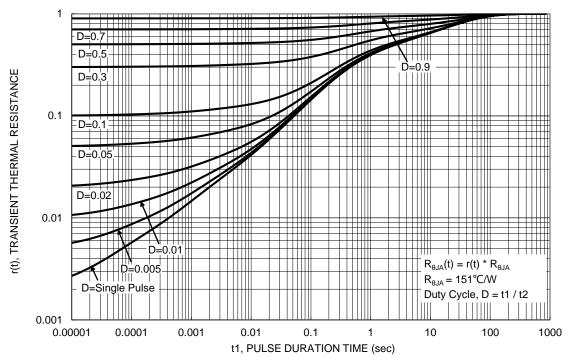


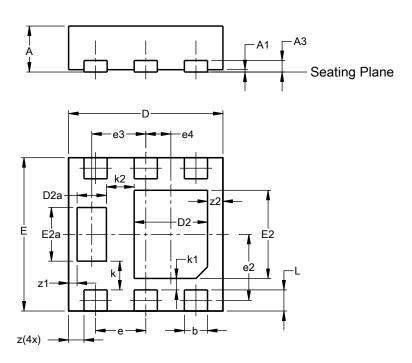
Figure 13. Transient Thermal Resistance



Package Outline Dimension

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)

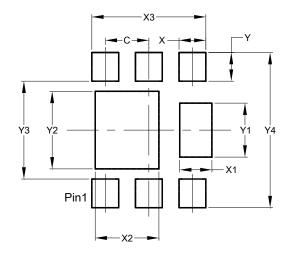


U-DFN2020-6							
(Type F)							
Dim	Min	Max	Тур				
Α	0.57	0.63	0.60				
A1	0.00	0.05	0.03				
A3	-	-	0.15				
b	0.25	0.35	0.30				
D	1.95	2.05	2.00				
D2	0.85	1.05	0.95				
D2a	0.33	0.43	0.38				
Е	1.95	2.05	2.00				
E2	1.05	1.25	1.15				
E2a	0.65	0.75	0.70				
е	0.65 BSC						
e2	0.863 BSC						
е3		0.70 BS	С				
e4	C).325 BS	SC				
k	0.37 BSC						
k1	0.15 BSC						
k2	0.36 BSC						
L	0.225 0.325 0.275						
z	0.20 BSC						
z1	0.110 BSC						
z2	0.20 BSC						
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)



Dimensions	Value (in mm)			
С	0.650			
Х	0.400			
X1	0.480			
X2	0.950			
Х3	1.700			
Y	0.425			
Y1	0.800			
Y2	1.150			
Y3	1.450			
Y4	2.300			



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